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XINGLIGHT®

焊接指导（1）

Guideline for Solder

1. 使用烙铁人手焊接

Hand Soldering

使用注意事项（1）
utions (1)

1. 贮存：

Storage

·

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.

· 30 60%RH

Before opening the package, the product should be kept at 30 or less and humidity less than 60% RH, and be used within a year.

· 30 40%RH 168 7

30 60%RH

After opening the package, the product should be stored at 30 or less and humidity less than 40%RH, and be soldered within 168 hours (7 days). It is recommended that the product be operated at the workshop condition of 30 or less and humidity less than 60%RH.

· LED

60 ± 5 24

If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (60 ± 5) for 24 hours.

2. 静电：

Static Electricity

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

使用注意事项（3）

Precautions (3)

4. 其他事项

Others